

# **SCT4026DE N-channel SiC power MOSFET**

V <sub>DSS</sub>	750V
R <sub>DS(on)</sub> (Typ.)	26mΩ
$I_{D}^{*1}$	56A
P <sub>D</sub>	176W

# Outline



# • Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

# Application

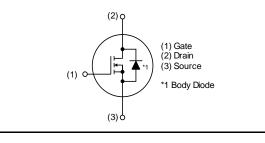
- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

# • Absolute maximum ratings $(T = 25^{\circ}C)$

•Absolute maximum ratings ( $I_c = 25^\circ$	C)			
Parameter		Symbol	Value	Unit
Drain - source voltage		V <sub>DSS</sub>	750	V
Continuous drain and source current		ı ı *1	56	A
$T_c = 100^{\circ}C$	$V_{GS} = V_{GS_{on}}$	ا <sub>D</sub> , I <sub>S</sub> *1	39	A
Pulsed drain current	$V_{GS} = V_{GS_{on}}$	I <sub>D,pulse</sub> *2	91	A
Body diode pulsed forward current	$V_{GS} = 0 V$	<sup>*3</sup> S,pulse	56	A
Body diode surge forward current	$V_{GS} = 0 V$	I <sub>S,pulse</sub> *4	91	A
Gate - source voltage (DC)		V <sub>GSS</sub>	-4 to +21	V
Gate - source surge voltage (t <sub>surge</sub> < 300	ns)	V <sub>GSS_surge</sub> *5	-4 to +23	V
Recommended turn-on gate - source dri	ve voltage	<sup>*6</sup> V <sub>GS_on</sub>	+15 to +18	V
Recommended turn-off gate - source drive voltage		$V_{GS_{off}}$	0	V
Virtual junction temperature		$T_{vj}$	175	°C
Range of storage temperature		T <sub>stg</sub>	-40 to +175	°C



# Inner circuit



# Packaging specifications

	Packing	Tube
	Reel size (mm)	-
Tuno	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT4026DE

# •Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

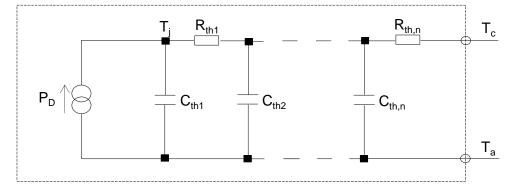
Doromotor	Symbol	Conditions		L locit			
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = 9.2mA$ $T_{vj} = 25^{\circ}C$	750	-	-	V	
Zero Gate voltage Drain current	I <sub>DSS</sub>	$V_{GS} = 0 V, V_{DS} = 750V$ $T_{vj} = 25^{\circ}C$ $T_{vi} = 150^{\circ}C$	-	1 10	80	μA	
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +21V$ , $V_{DS} = 0V$	-	-	100	nA	
Gate - Source leakage current		$V_{GS} = -4V$ , $V_{DS} = 0V$	-	-	-100	nA	
Gate threshold voltage	$V_{GS(th)}{}^{*7}$	$V_{DS} = 10V, I_{D} = 15.4mA$	2.8	-	4.8	V	
Static Drain - Source on - state resistance	R <sub>DS(on)</sub> *8	$V_{GS} = 18V, I_D = 29A$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 150^{\circ}C$	-	26 44	34 -	mΩ	
Gate input resistance	$R_G$	f = 1MHz, open drain	-	1	-	Ω	

#### •Thermal resistance

Parameter	Symbol	Values			Unit
Falanletei	Symbol	Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	$R_{thJC}^{*9}$	-	0.65	0.85	K/W

# •Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R <sub>th1</sub>	1.1 ×10 <sup>-1</sup>		C <sub>th1</sub>	5.8 ×10 <sup>-4</sup>	
R <sub>th2</sub>	2.5 ×10 <sup>-1</sup>	K/W	C <sub>th2</sub>	2.3 ×10 <sup>-3</sup>	Ws/K
R <sub>th3</sub>	2.9 ×10 <sup>-1</sup>		C <sub>th3</sub>	1.1 ×10 <sup>-2</sup>	





•Electrical characteristics ( $T_{vj} = 25$ °C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			L los it	
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Transconductance	g <sub>fs</sub> *8	$V_{DS} = 10V, I_{D} = 29A$	-	16	-	S	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	2320	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 500V	-	111	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	9	-		
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	-	143	-	pF	
Total Gate charge	Q <sub>g</sub> *8	$V_{DS} = 500V$ $I_{D} = 29A$	-	94	-		
Gate - Source charge	Q <sub>gs</sub> *8	$V_{GS} = 18V$	-	20	-	nC	
Gate - Drain charge	Q <sub>gd</sub> *8	See Fig. 1-1, 1-2.	-	23	-		
Turn - on delay time	t <sub>d(on)</sub> *8	$V_{DS} = 500V$ $I_{D} = 29A$	-	10	-		
Rise time	t <sub>r</sub> *8	V <sub>GS</sub> = +18V / 0V	-	39	-	20	
Turn - off delay time	t <sub>d(off)</sub> *8	$R_G = 6.8\Omega, L = 250\mu H$ E <sub>on</sub> includes diode	-	44	-	ns	
Fall time	t <sub>f</sub> *8	reverse recovery $L_{\sigma} = 50 \text{nH}, C_{\sigma} = 10 \text{pF}$	-	16	-		
Turn - on switching loss	E <sub>on</sub> *8	See Fig. 2-1, 2-2, 2-3.	-	460	-		
Turn - off switching loss	E <sub>off</sub> *8		-	120	-	μJ	



# ●Body diode electrical characteristics (Source-Drain) (T<sub>vj</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Conditions		Values		Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Onit
Forward voltage	$V_{SD}^{*8}$	$V_{GS} = 0V, I_D = 29A$	-	3.3	-	V
Reverse recovery time	t <sub>rr</sub> *8	$I_F = 29A$ $V_R = 500V$	-	19	-	ns
Reverse recovery charge	Q <sub>rr</sub> *8	di/dt = 1500A/µs	-	100	-	nC
Peak reverse recovery current	I <sub>rrm</sub> *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	11	-	А

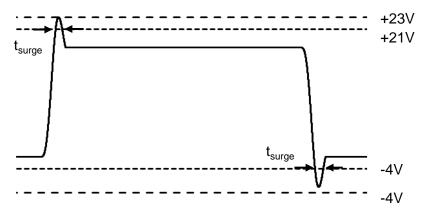
\*1 Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

\*2  $P_W \le 10\mu s$ , Duty cycle  $\le 1\%$ 

\*3 Only for body-diode, Repititive pulse, PW  $\leq$  500ns, Duty cycle  $\leq$  5%

\*4 When used as a protective function, PW  $\leq$  10µs

\*5 Example of acceptable V<sub>GS</sub> waveform



- \*6 Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 10V as doing so may cause thermal runaway.
- \*7 Tested after applying  $V_{GS}$  = 21V for 100ms.

## \*8 Pulsed

\*9 Measured conformable to JESD51-14.

See the application note "rthjc\_measurement\_and\_usage\_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc\_measurement\_and\_usage\_an-e.pdf



 $\mathsf{P}_{\mathsf{W}}$ 

<100ns\*

1µs\*

10µs\*

100µs

1ms

10ms

1000 10000

1

### Electrical characteristic curves

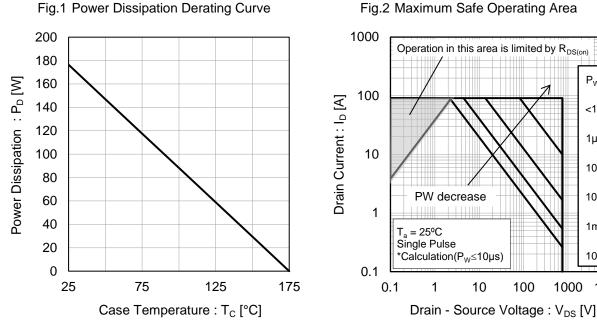
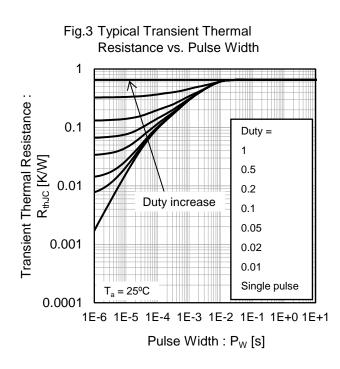


Fig.2 Maximum Safe Operating Area

1

10

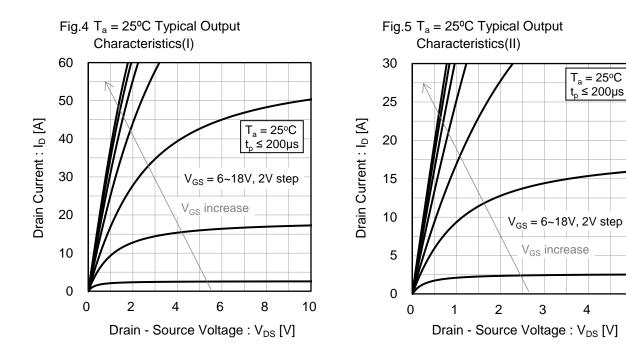
100



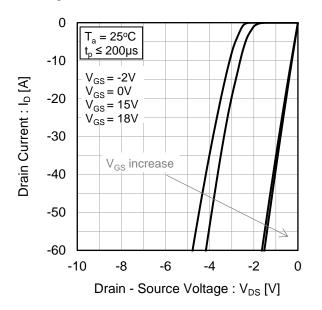


5

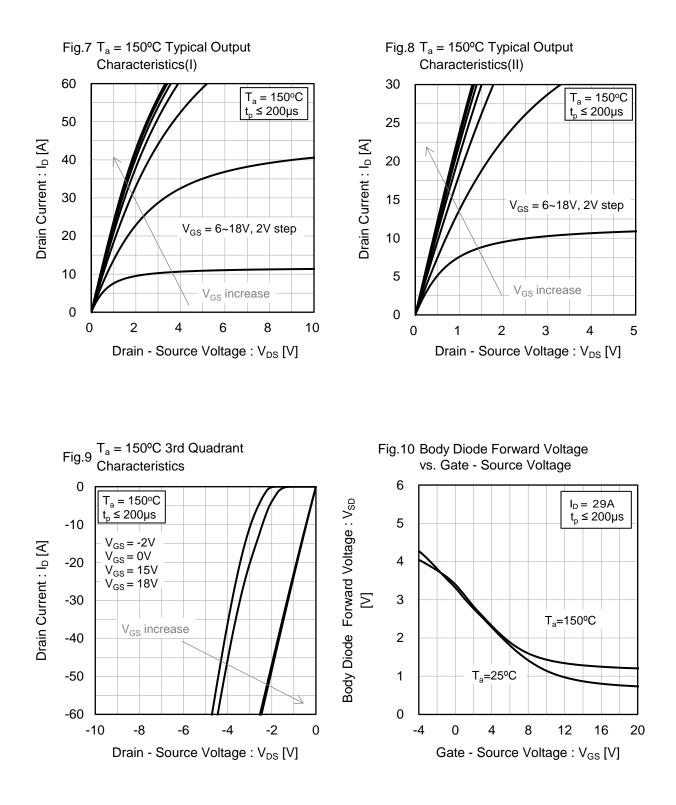
# •Electrical characteristic curves



#### Fig.6 $T_a = 25^{\circ}C$ 3rd Quadrant Characteristics









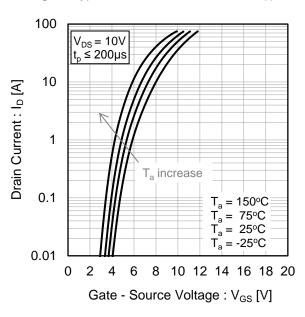
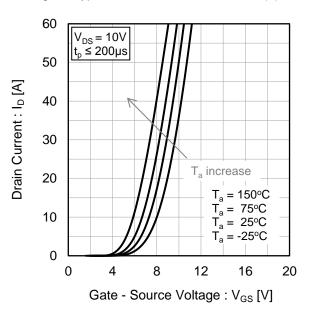


Fig.11 Typical Transfer Characteristics (I)

Fig.12 Typical Transfer Characteristics (II)



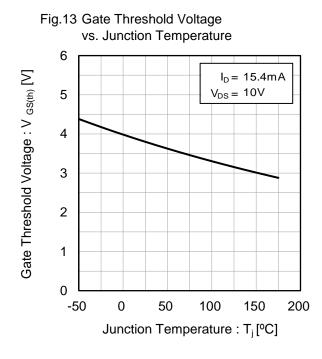
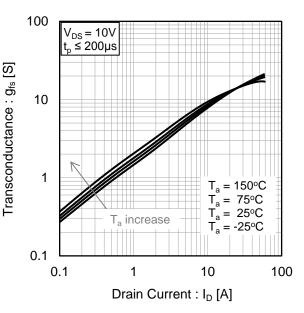
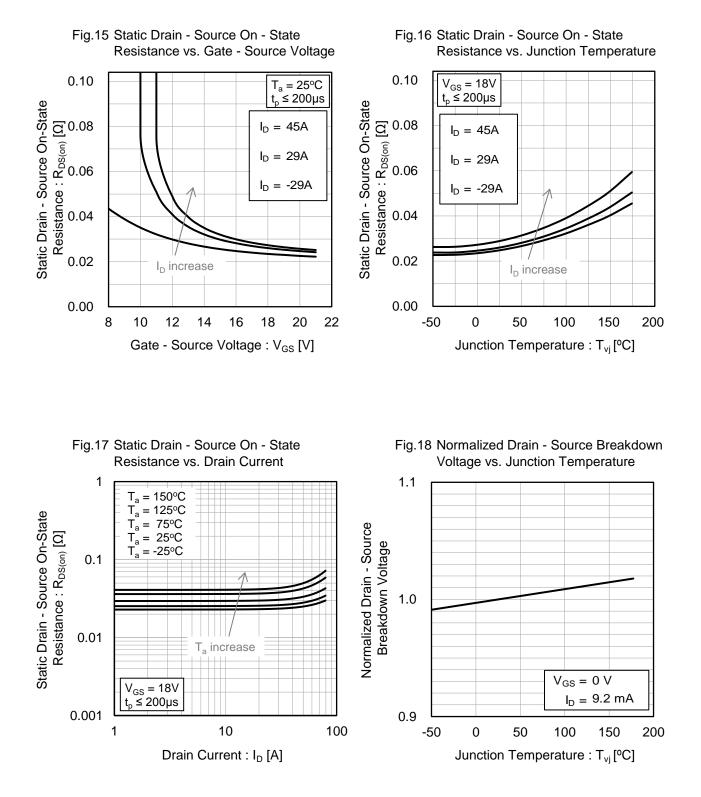


Fig.14 Transconductance vs. Drain Current

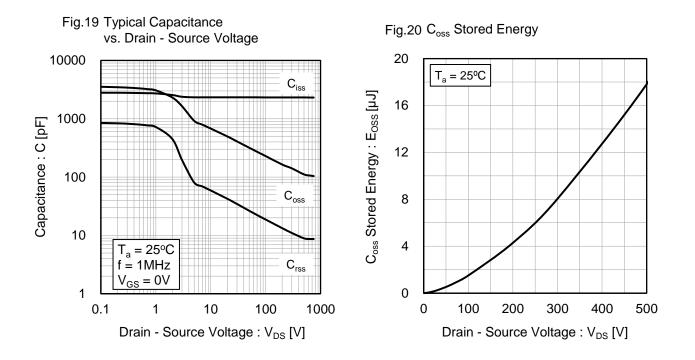




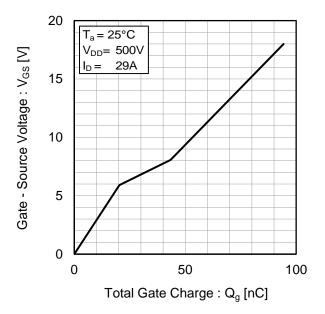


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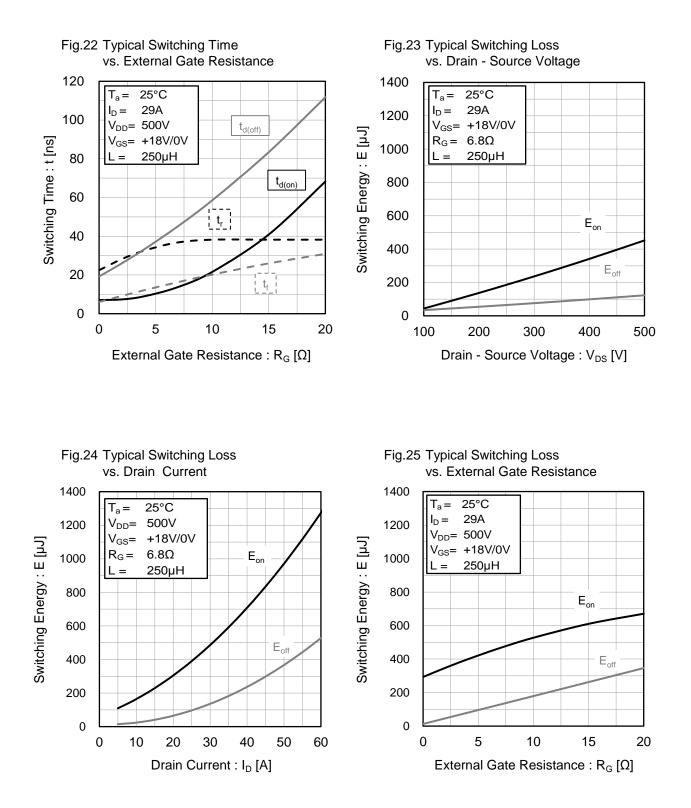




#### Fig.21 Dynamic Input Characteristics









# Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

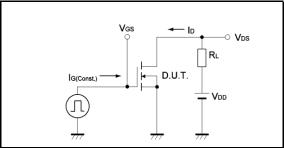
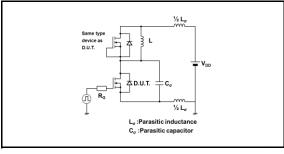


Fig.2-1 Switching Characteristics Measurement Circuit



# Fig.2-3 Waveforms for Switching Energy Loss

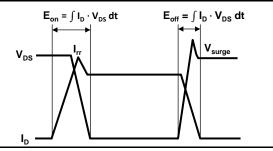
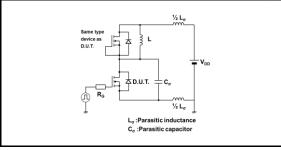
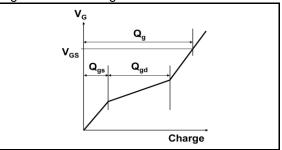


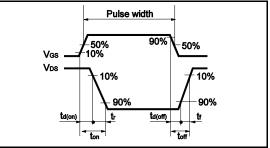
Fig.3-1 Reverse Recovery Time Measurement Circuit



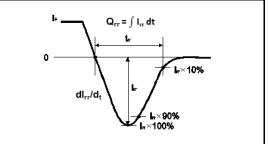
#### Fig.1-2 Gate Charge Waveform



#### Fig.2-2 Waveforms for Switching Time



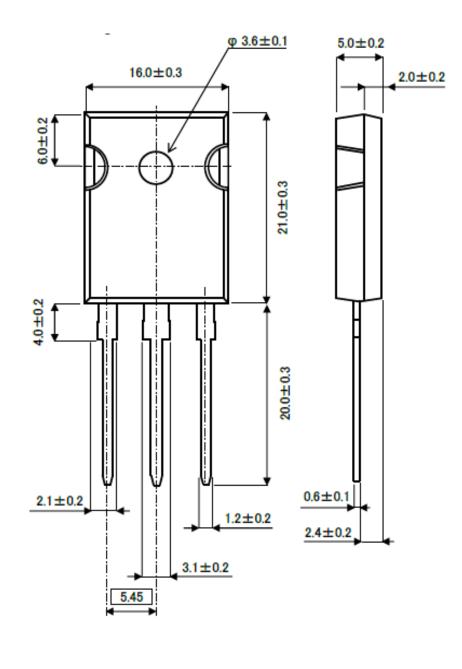
#### Fig.3-2 Reverse Recovery Waveform

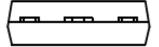






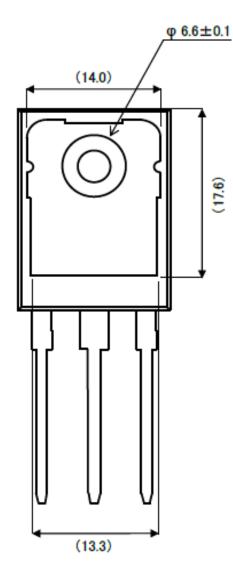
# Package Dimensions





Unit: mm



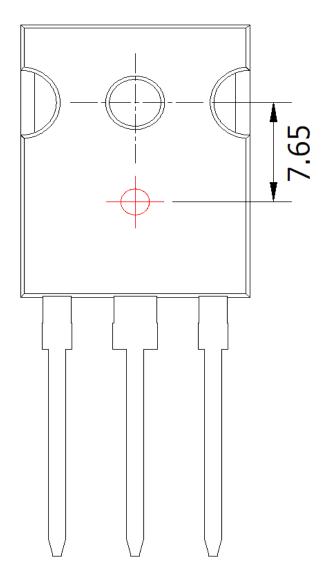


Unit: mm





# •Die Bonding Layout



 $\boldsymbol{\cdot}$  Front view of the packaging.

·Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm



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